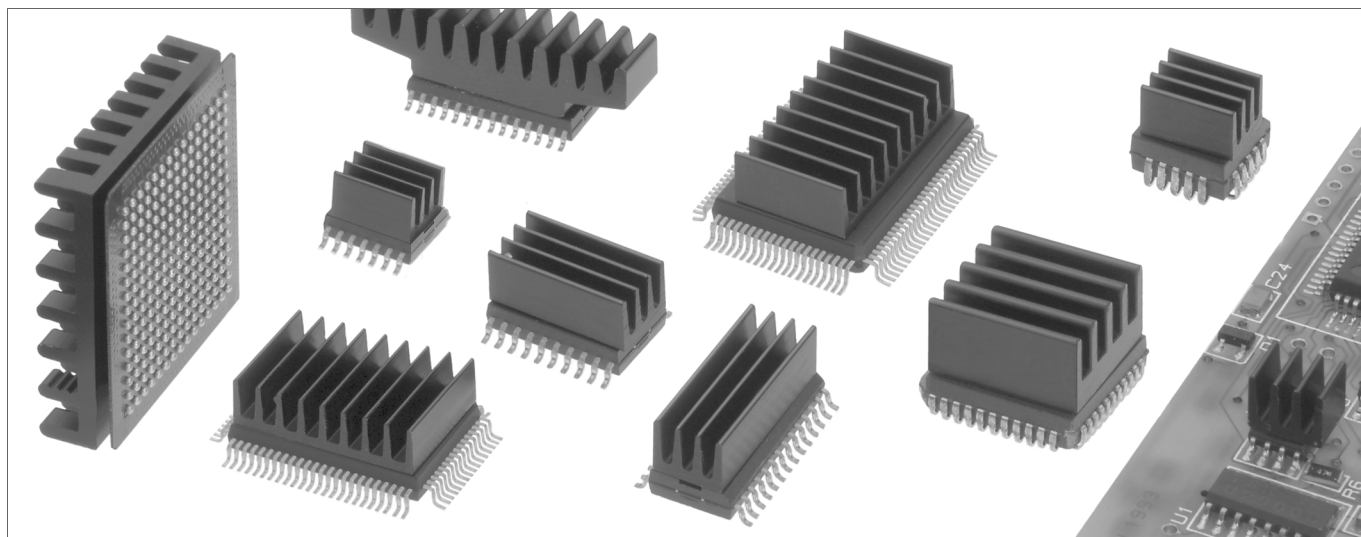
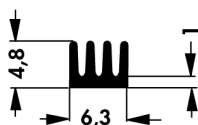
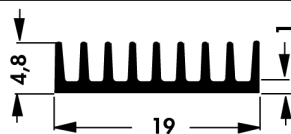


Heatsinks for DIL-IC, PLCC and SMD
Heatsinks for SMD


- particularly suitable for SMD components
- low profile
- reduced weight
- effective heat dissipation
- can be glued directly onto the component
- solderable versions
- customer specific versions on request
- special packaging like tape and reel, bar magazin, tary etc. on request



art. no.	R_{th} [K/W]	\leftrightarrow [mm]
ICK SMD A 5 ...	123	5
ICK SMD A 8 ...	87	8
ICK SMD A 10 ...	75	10
ICK SMD A 13 ...	63	13
ICK SMD A 17 ...	51	17
ICK SMD A 22 ...	34	22



art. no.	R_{th} [K/W]	\leftrightarrow [mm]
ICK SMD B 5 ...	56	5
ICK SMD B 7 ...	47	7
ICK SMD B 10 ...	35	10
ICK SMD B 13 ...	29	13
ICK SMD B 19 ...	22	19

please indicate: ... surface treatment
SA=black anodised
MI=solderable surface

B 25

Aluminium oxide wafers
 Mica wafers
 Kapton insulator washers
 Insulating clamping parts

→ E 9 – 10
 → E 11
 → E 8
 → E 35

Profiles for PCB components
 Heatsinks for PCB
 SMD-heatsinks
 Profiles for PCB mounting

→ A 89
 → A 87
 → B 25 – 27
 → A 87 – 108